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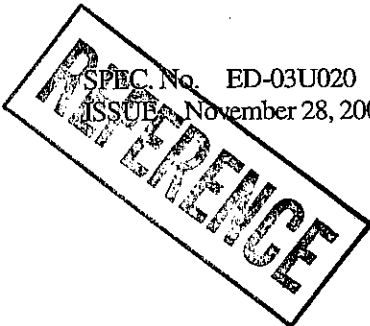
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SHARP

OPTO-ELECTRONIC DEVICES DIVISION
ELECTRONIC COMPONENTS GROUP
SHARP CORPORATION

SPECIFICATION

DEVICE SPECIFICATION FOR

Infrared Detecting unit for Remote Control

MODEL No.

GP1UX51QS series

Specified for

Enclosed please find copies of the Specifications which consists of 11 pages including cover.
After confirmation of the contents, please be sure to send back copies of the Specifications
with approving signature on each.

CUSTOMER'S APPROVAL

DATE

BY

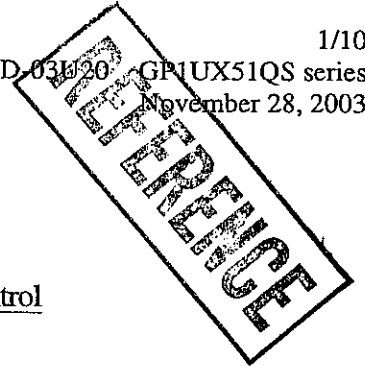
PRESENTED

DATE

BY

Handwritten signature in black ink, appearing to be "K. H." or similar.

K.Hachimura,
Department General Manager of
Engineering Dept, II
Opto-Electronic Devices Div.
ELECOM Group
SHARP CORPORATION



Product name : Infrared Detecting unit for Remote Control

Model No. : GP1UX51QS series

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2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below.

(Precautions)

- (1) This product is designed for use in the following application areas ;

(• OA equipment • Audio visual equipment • Home appliances
• Telecommunication equipment (Terminal))

If the use of the product in the above application areas is for equipment listed in paragraphs (2) or (3), please be sure to observe the precautions given in those respective paragraphs.

- (2) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as ;

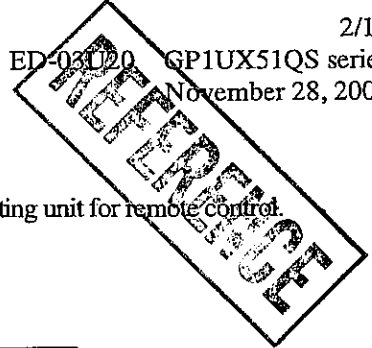
(• Transportation control and safety equipment (aircraft, train, automobile etc.)
• Traffic signals • Gas leakage sensor breakers • Rescue and security equipment
• Other safety equipment etc.)

- (3) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as ;

(• Space equipment • Telecommunication equipment (for trunk lines)
• Nuclear power control equipment • Medical equipment etc.)

- (4) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above three paragraphs.

3. Please contact and consult with a Sharp sales representative for any questions about this product.



1. Application

This specifications applies to the model marked "○" in the following models of infrared detecting unit for remote control.

The model list of GP1UX51QS series

Application	Model No.	B.P.F. center frequency (TYP)
	GP1UX51QS	40 kHz
	GP1UX510QS	36 kHz
	GP1UX511QS	38 kHz
	GP1UX512QS	36.7 kHz
	GP1UX513QS	32.75 kHz

Main application : TV set, VCR, Radio cassette recorder, Stereo

2. Outline Refer to the attached sheet, Page 7.

3. Ratings and characteristics Refer to the attached sheet, Page 4 to 6.

4. Reliability Refer to the attached sheet, Page 8.

5. Outgoing inspection Refer to the attached sheet, Page 9.

6. Supplement

1) This infrared detecting unit for remote control satisfies each performance requirements in para. 3.5, in the standard optical system in Fig.2.

2) This product is built-in photodiode.

3) Product mass : Approx. 0.35g

4) This product shall not contain the following materials.

Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFC_s, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methyl chloroform)

5) Brominated flame retardants

Specific brominated flame retardants such as the PBBO_s and PBB_s are not used in this device at all.

6) Packing specification : Refer to the attached sheet, Page 10.

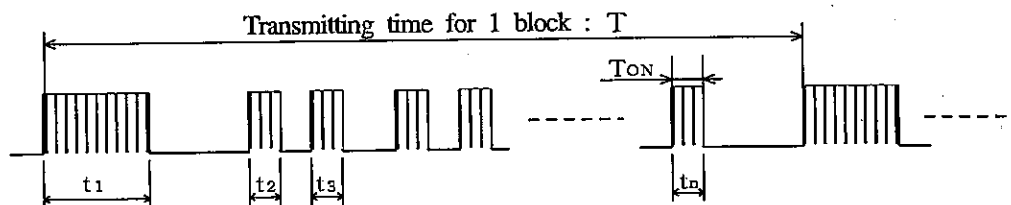
7) Country of origin : China

8) This product doesn't use lead.

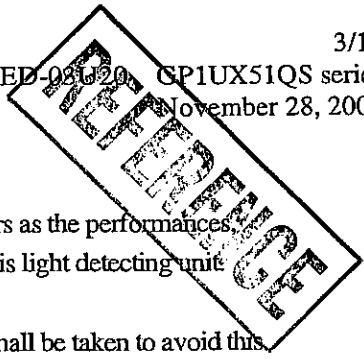
7. Notes

1) Transmitting code

When this infrared remote control detecting unit shall be adopted for wireless remote control, please use it with the signal format of transmitter, which total duty ratio D_t (Emitting time $\sum_{N=1}^n t_N$ / Transmitting time for 1 block T) is 40% or less. ON signal time T_{ON} (Pulse width of the presence of modulated IR) should be $200 \mu s$ or more. In case that the signal format of total duty and ON signal time is out of above conditions, there is a case that reception distance is much reduced or output is not appeared.



$$D_t = \left(\sum_{N=1}^n t_N / T \right) \times 100 (\%)$$



2) Transmitter

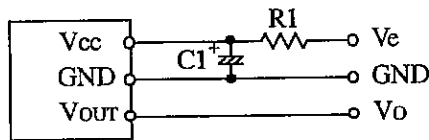
Please use a light emitting unit (remote control transmitter) taking into consideration such factors as the performances characteristics and operating condition of the light emitting element and the characteristics of this light detecting unit

3) Detector face and cleaning

If the surface of detector is smeared with dust or dirt, it may cause faulty operation. Caution shall be taken to avoid this. And do not touch the detector surface. If the surface was smeared, wipe it clean with soft cloth. If any solvent is needed, Methyl alcohol, Ethyl alcohol, or Isopropyl alcohol should be used. Please don't carry out washing. Because, after washing the remainder in solvent or flux in this device cause malfunction. Marking on this device is defaced by washing.

4) Mounting this product

- It shall not be applied the terminal with unnecessary stress.
- Please don't push the detecting side (photodiode) from external.
- In order to prevent electrostatic discharge of integrated circuit, human body and soldering iron, etc. shall be grounded.
- Since conductive thermoplasticity is used in 2nd mold resin, please be carefully not to contact to PCB land pattern.
- When mounting, please mount the external circuit below. (CR filter)
(External parts should be mounted as close as possible to the sensor.)



(Circuit fixed number)
R1=47 Ω ±5%
C1=47 μ F

The circuit constant is an example. It is difference from mounting equipment. Please select it by your mounting equipment. This device has a transistor as protection element between Vcc and GND to improve anti-static electricity proof. Please be carefully not to apply exceeding the absolute maximum ratings of applying voltage and continuous high voltage spike noise because there is cases that transistor will be short by secondary breakdown generally. In order to do difficultly, Please add CR filter (47 Ω (1/10W), 10 μ F or more) such as external circuit example above near Vcc.

5) Characteristics of this product

- There is a possibility that noise on output may be caused by environmental condition etc. even if there is no input transmission signal.
- Please shall confirm operation or your actual machine. Because the output pulse width of this product is fluctuated by environmental conditions such as signal format, temperature, distance from transmitter, and so on.

6) Soldering

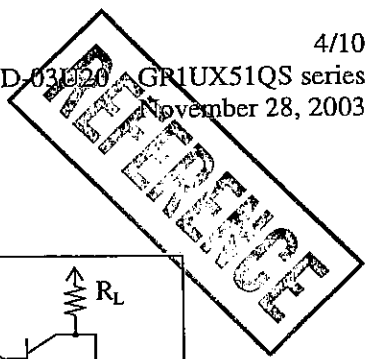
- In case that this product is kept in high humidity condition, it may be hard to solder, please be careful enough about storage method. Depend on the flux you select, there are different solderabilities, so please select a suitable flux and use it.
- Please don't do soldering this product by reflow.
- Please make sure in case of hand soldering that you use the solder iron with less than 45W power and the solder iron point (edge) temperature is less than 320°C within 3 seconds, and also don't add any force to lead frame directly. And please make sure never to touch 2nd mold resin by a soldering.

7) Use condition

Please use this device away from the dew drop. Be aware that the dew drop rusts shield case and others, may affect the electric characteristics.

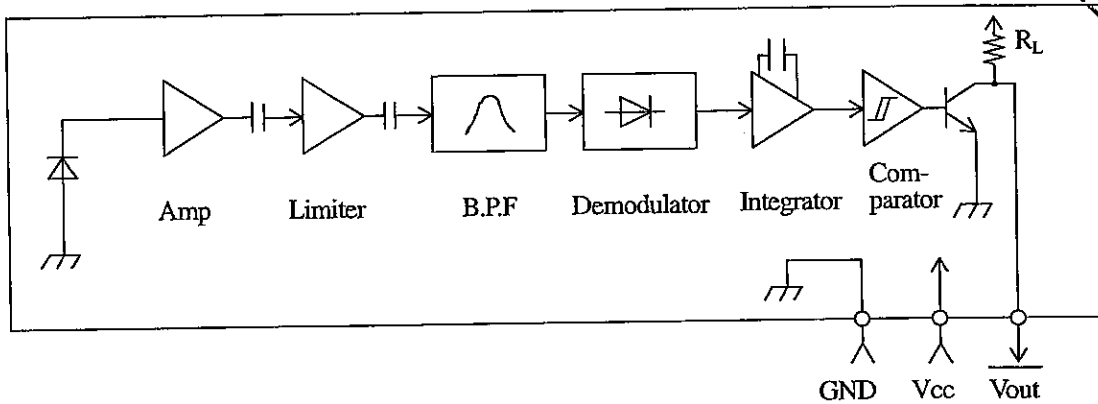
8) Outlook of device

The lead frame may be deformed since the device is packed in vinyl bag.



3. Ratings and characteristics

3.1 Schematic

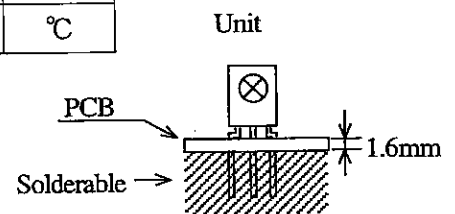


3.2 Absolute maximum ratings

Parameter	Symbol	Ratings	Unit
Supply voltage	Vcc	0 to 6.0	V
Operating temperature	Topr	-10 to +70 ※1	°C
Storage temperature	Tstg	-20 to +70	°C
Soldering temperature	Tsol	260 (Soldering time : 5s) ※2	°C

※1) No dew drop

※2) 1.6mm at mounting on single-sided PCB



3.3 Recommended operating conditions

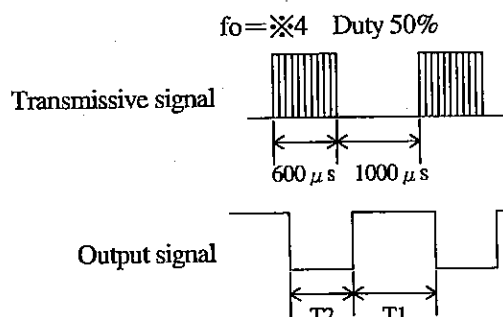
Parameter	Symbol	Operating condition	Unit
Supply voltage	Vcc	4.5 to 5.5	V

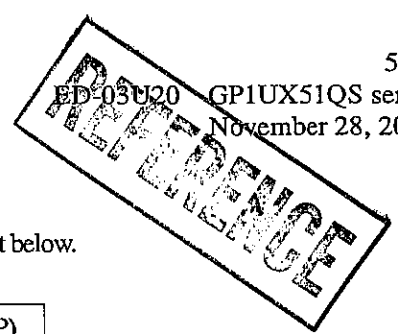
3.4 Electrical characteristics

(Unspecified Ta=25°C, Vcc=+5V)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit	Remark
Current dissipation	Icc	-	0.5	0.6	mA	No input light
High level output voltage	V _{OH}	Vcc-0.5	-	-	V	※3
Low level output voltage	V _{OL}	-	-	0.45	V	※3 I _{OL} =1.6mA
High level pulse width	T ₁	600	-	1200	μs	※3
Low level pulse width	T ₂	400	-	1000	μs	※3
B.P.F. center frequency	f ₀	-	※4	-	kHz	
Output pull-up resistance	R _L	70	100	130	kΩ	

※3) The burst wave as shown in the figure on the right shall be transmitted by the transmitter shown in Fig.1. However, the carrier frequency of transmitter is same as ※4 kHz. Measuring shall be from just after starting the transmission until 50 pulse.





※4) B.P.F. center frequency : f_0 of each model is shown in the list below.

Model No.	B.P.F. center frequency (TYP)
GP1UX51QS	40 kHz
GP1UX510QS	36 kHz
GP1UX511QS	38 kHz
GP1UX512QS	36.7 kHz
GP1UX513QS	32.75 kHz

3.5 Performance

The output signal of this infrared detecting unit shall satisfy the following requirements with the transmitter shown in Fig.1 used in the standard optical system in Fig.2.

3.5.1 Characteristics of linear reception distance

The output signal shall satisfy the electrical characteristic requirements in para. 3.4 at $L=0.2$ to 8.5m , (※5) $E_v < 10\text{lx}$, $\phi = 0^\circ$ in Fig.2.

3.5.2 Characteristics of sensitivity angle reception distance

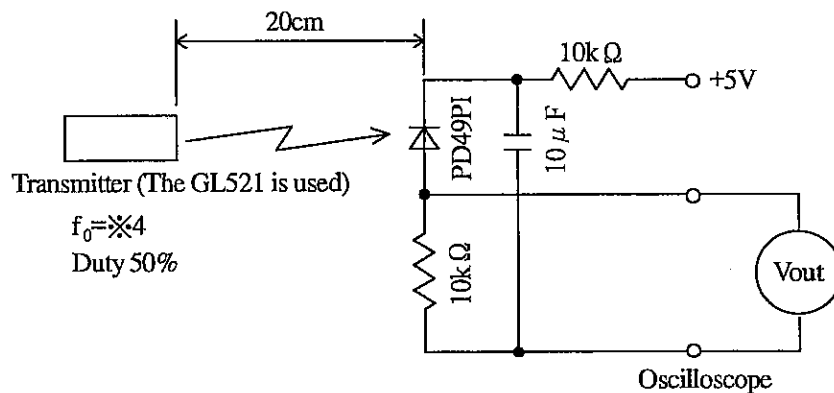
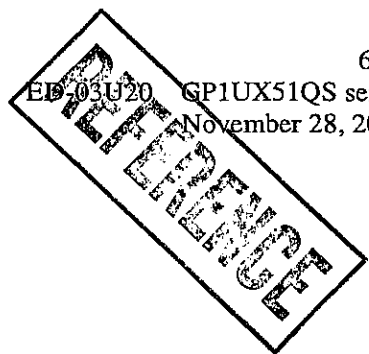
The output signal shall satisfy the electrical characteristic requirements in para. 3.4 at $L=0.2$ to 6.0m , (※5) $E_v < 10\text{lx}$, $\phi \leq 30^\circ$ in Fig.2.

3.5.3 Characteristics of anti-outer peripheral light reception distance

The output signal shall satisfy the electrical characteristic requirements in para. 3.4 at $L=0.2$ to 4.0m , (※5, ※6) $E_v \leq 300\text{lx}$, $\phi = 0^\circ$ in Fig.2.

※5) It refers to detector face illuminance.

※6) Outer peripheral light source : CIE standard light source A shall be used and placed at 45° from the perpendicular axis at the detector face center.



In the figure above, the transmitter shall be set as the output V_{out} (p-p) will be 40mV.

Note that the PD49PI in this application is the one with short-circuit current

$I_{sc} = 2.6 \mu A$ measured at $E_v = 100 \text{lx}$. (E_v is the illuminance by CIE standard light source A (tungsten lamp)).

Fig. 1 Transmitter

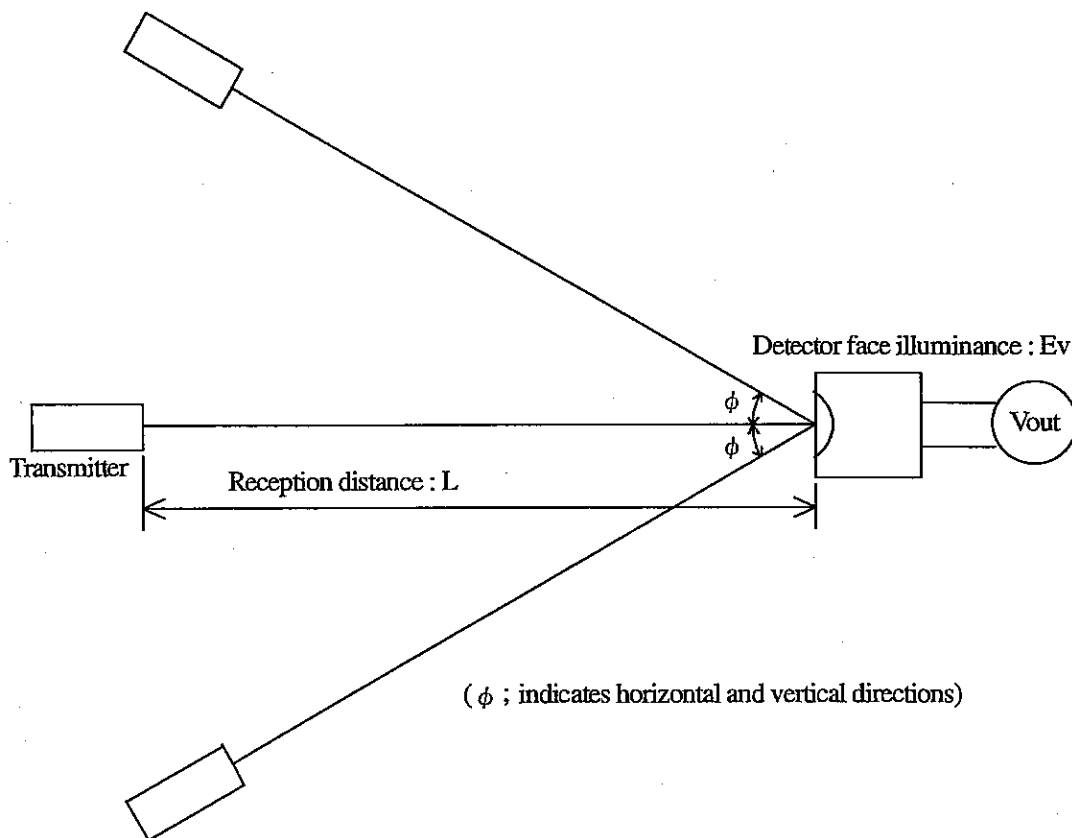
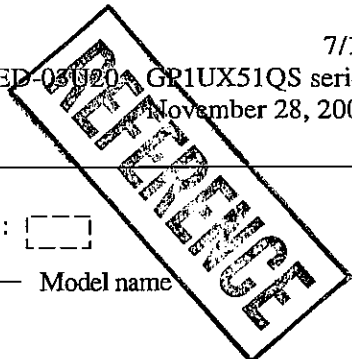


Fig.2 Standard optical system



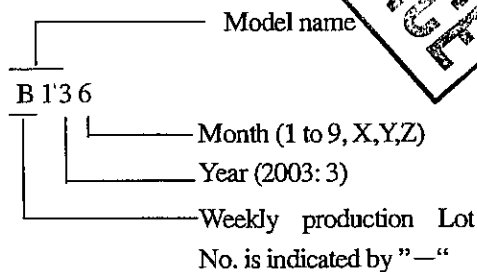
Stamp list

Model No.	Stamp
GP1UX51QS	B
GP1UX511QS	B1
GP1UX512QS	B2
GP1UX513QS	B3
GP1UX510QS	B0

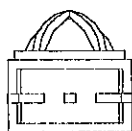
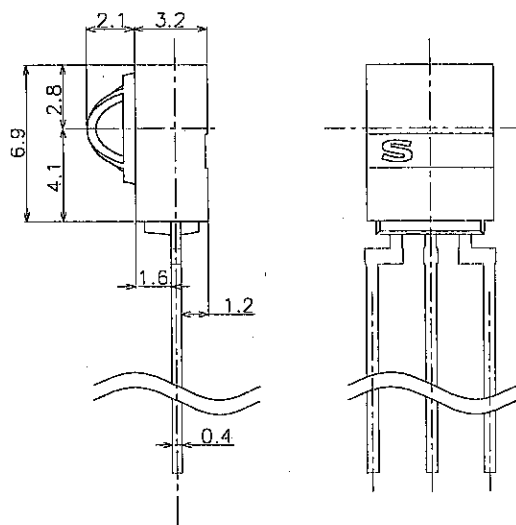
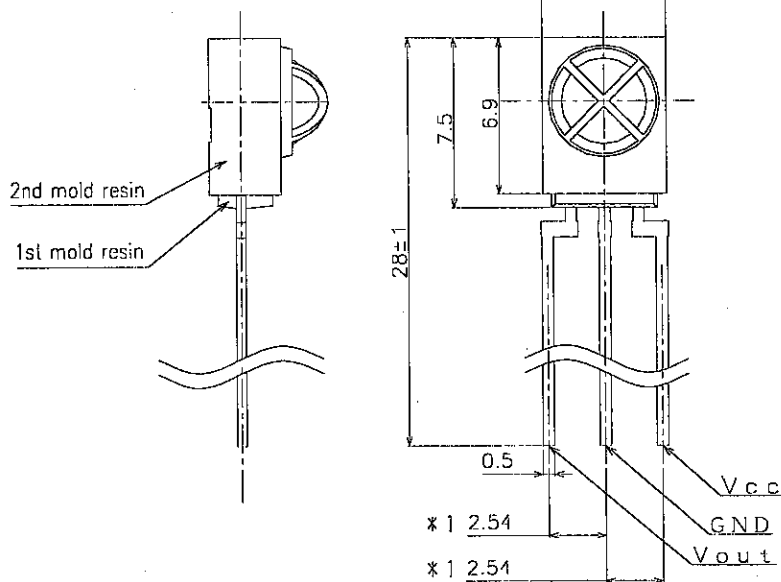
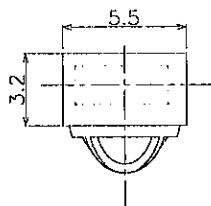
Production week indication list

Lot No.	Week
B136	1st
B136	2nd
B136	3rd
B136	4th
B136	5th
B136	6th

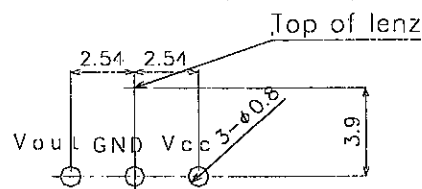
* Stamp area :



* Carved seal Sharp mark

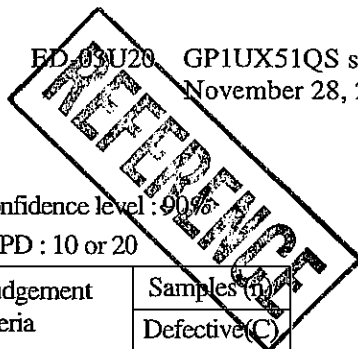


Example of mounting drawing from solder side (Reference)



- *1: Indicates root dimensions of connector
- Unspecified tolerance : ± 0.3
- Lead material : Fe
- Lead finish : Solder dip (Sn, Ag, Cu).
- 1st mold resin : Epoxy resin
- 2nd mold resin : Conductive resin (Polycarbonate, black)
- Product mass : Approx. 0.35g
- Crack of mesh portion should be less than two point, one portion length should be 0.4mm MAX.
Burr should not affect the electrical characteristics.

Scale	Name	GP1UX51QS series Outline Dimensions
3/1		
Unit	Drawing No.	RUD3Y45
1=1/1mm		



4. Reliability

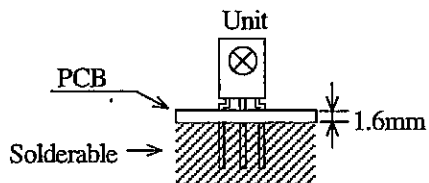
The reliability of products shall satisfy items listed below.

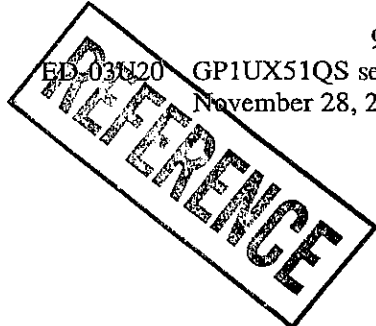
Confidence level : 90%

LTPD : 10 or 20

Test Items	Test Conditions	Failure Judgement Criteria	Samples (n)
			Defective (C)
Terminal strength (Tension)	Weight : 5N, 30s / each terminal	Performance test in para. 3.5 should not be satisfied.	n=11, C=0
Terminal strength (Bending)	Weight : 2.5N 0° -90° -0° , 2 times / each terminal		n=11, C=0
Shock	Acceleration : 1000m/s ² , 6ms 3 directions / 3 times		n=11, C=0
Variable frequency vibration	Frequency range : 10 to 55Hz/ sweep 1min Overall amplitude : 1.5mm X, Y, Z/2h each		n=11, C=0
* High temp. and high humidity storage	Ta=40°C, 90%RH, t=240h		n=22, C=0
* High temp. storage	Ta=70°C, t=240h		n=22, C=0
* Low temp. storage	Ta=-20°C, t=240h		n=22, C=0
* Temperature cycling	1cycle -20°C to +70°C (30min) (30min) 20 cycles test		n=22, C=0
* Operation life (High temperature)	Ta=70°C, Vcc=5V, t=240h		n=22, C=0
Solder heat	MAX. 260°C, 5s (1.6mm at mounting on single-sided PCB)	n=11, C=0	

In the test *mark above, the sample to be tested shall be left at normal temperature and humidity for 2hours after it is taken out of the chamber. (No dew drop)





5. Outgoing inspection

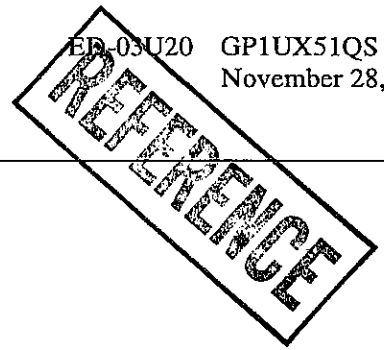
(1) Inspection lot

Inspection shall be carried out per each delivery lot.

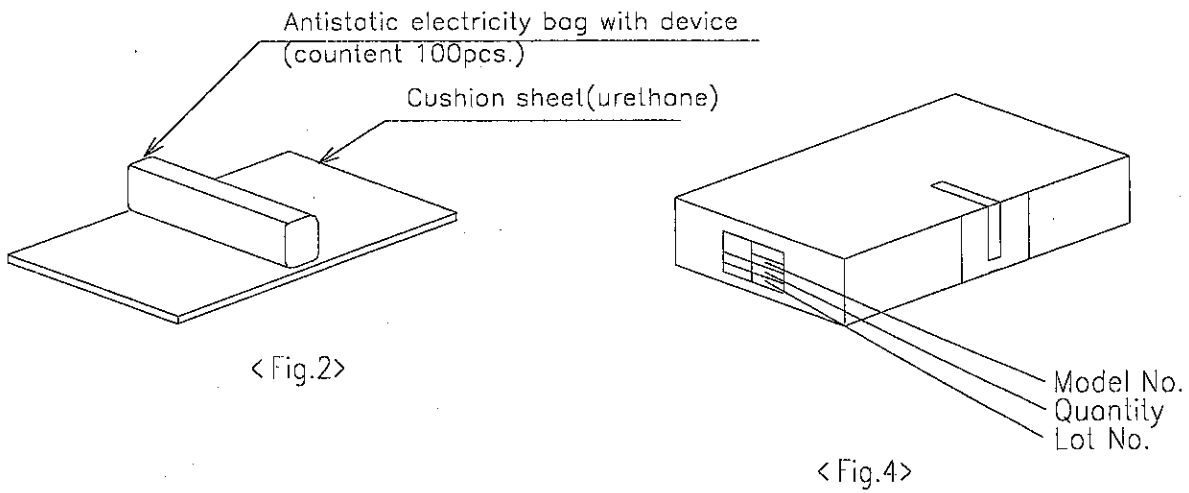
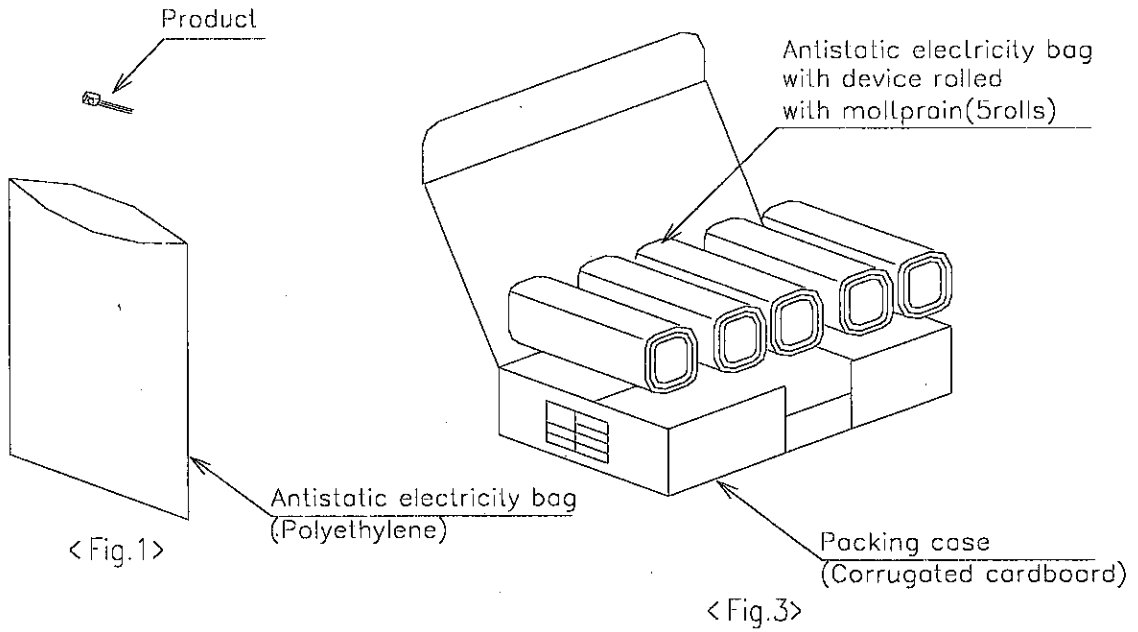
(2) Inspection method

A single sampling plan, normal inspection level II based on ISO 2859 shall be applied.

Classification of Defects		Inspection Items	AQL (%)
Major defect	1	Electrical characteristic defect of V_{OH} , V_{OL} , T_1 and T_2 in para. 3.4.	0.4
	2	Distance between signal terminal and 2nd resin (0.2mm or more) (Except for GND terminal)	
	3	It should have no remarkable stains and cracks that give any influence of electrical characteristic on light detecting face.	
Minor defect	1	Deformation of 2nd resin (Satisfying outline dimensions of item 2)	1.5
	2	Stamp, Carved seal (It should be possible to read stamp and carved seal of item 2. Stamp and carved seal should be indicated at fixed position.)	



Package drawings



Packaging method

1. Put products of 100pcs. in the antistatic electricity bag. (Fig. 1)
 2. A pack (item1) should be wrapped by cushion sheet (urethane). And five packs should contain in one box. (Fig. 2 , Fig. 3)
 3. Seal the packing box , and print the model No., quantity and lot No. (500pcs. / a packing box) (Fig. 4)
- Product mass at 500pcs./package : Approximately 270g

Scale	Name	GP1UX51QS series Packing specification
Unit		
1= / mm	Drawing No.	RUD3Y46